

UNITED STATES PATENT AND TRADEMARK OFFICE

BEFORE THE PATENT TRIAL AND APPEAL BOARD

SAMSUNG ELECTRONICS CO., LTD.,
Petitioner,

v.

DANIEL L. FLAMM,
Patent Owner.

Case IPR2016-01510
Patent RE40,264 E

Before MICHAEL R. ZECHER, CHRISTOPHER L. CRUMBLEY, and
JO-ANNE M. KOKOSKI, *Administrative Patent Judges*.

ZECHER, *Administrative Patent Judge*.

DECISION

Denying Institution of *Inter Partes* Review
35 U.S.C. § 314(a) and 37 C.F.R. § 42.108

Tokyo Electron Limited
EXHIBIT 1018
IPR Petition for

I. INTRODUCTION

Petitioner, Samsung Electronics Co., Ltd. (“Samsung”), filed a Petition requesting an *inter partes* review of claims 13–26, 64, and 65 (“the challenged claims”) of U.S. Patent No. RE40,264 E (Ex. 1001, “the ’264 patent”). Paper 1 (“Pet.”). Patent Owner, Daniel L. Flamm (“Flamm”), filed a Preliminary Response. Paper 5 (“Prelim. Resp.”).

Under 35 U.S.C. § 314(a), an *inter partes* review may not be instituted unless the information presented in the Petition shows “there is a reasonable likelihood that the petitioner would prevail with respect to at least 1 of the claims challenged in the petition.” Taking into account the arguments presented in Flamm’s Preliminary Response, we conclude that the information presented in the Petition does not establish that there is a reasonable likelihood that Samsung would prevail in challenging any of claims 13–26, 64, and 65 of the ’264 patent as unpatentable under 35 U.S.C. § 103(a). We, therefore, *deny* the Petition.

A. Related Matters

The parties represent that the ’264 patent is at issue in a district court case captioned *Flamm v. Samsung Electronics Co.*, No. 1:15-cv-613-LY (W.D. Tex.), which was transferred to the Northern District of California on April 27, 2016, where it was re-captioned No. 5:16-cv-2252-BLF (N.D. Cal.). Pet. 1; Paper 4, 2. Samsung further represents that the ’264 patent was at issue in a number of *inter partes* review proceedings filed by a different petitioner; however, the Board only granted institution in two proceedings, each of which has since terminated following settlement. *See* Pet. 1 n.1. In addition to this Petition, Samsung filed another petition

challenging the patentability of claims 27, 31, 32, 34, 37, 40, 41, 44, 47, 48, and 50 of the '264 patent in Case IPR2016-01512. *Id.* at 1–2.

B. The '264 Patent

The '264 patent, titled “Multi-Temperature Processing,” reissued April 29, 2008, from U.S. Patent Application No. 10/439,245 (“the '245 application”), filed on May 14, 2003. Ex. 1001, at [54], [45], [21], [22]. The '264 patent is a reissue of U.S. Patent No. 6,231,776 B1 (“the '776 patent”), which issued May 15, 2001, from U.S. Patent Application No. 09/151,163 (“the '163 application”), filed September 10, 1998. *Id.* at [64]. The '264 patent is directed to a method “for etching a substrate in the manufacture of a device,” where the method “provide[s] different processing temperatures during an etching process or the like.” *Id.* at Abstract. The apparatus used in the method is shown in Figure 1, reproduced below.

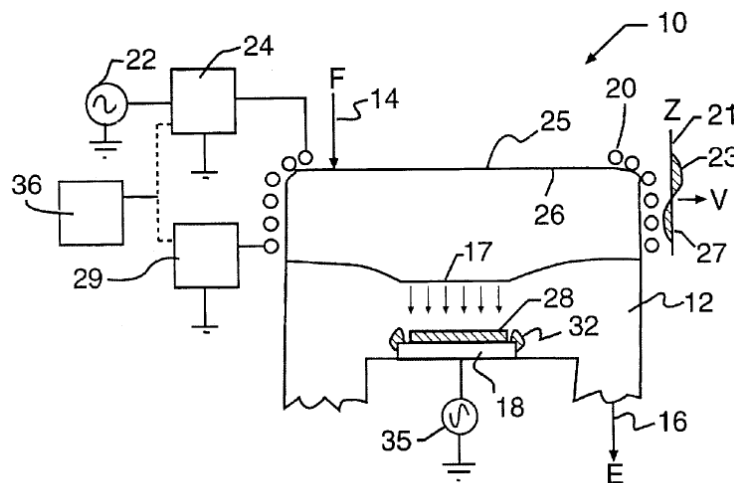


FIG. 1

Figure 1 depicts a substrate (product 28, such as a wafer to be etched) on a substrate holder (product support chuck or pedestal 18) in a chamber (chamber 12 of plasma etch apparatus 10). *Id.* at 3:24–25, 3:32–33, 3:40–41.

Figures 6 and 7, reproduced below, depict a temperature-controlled substrate holder and temperature control systems.

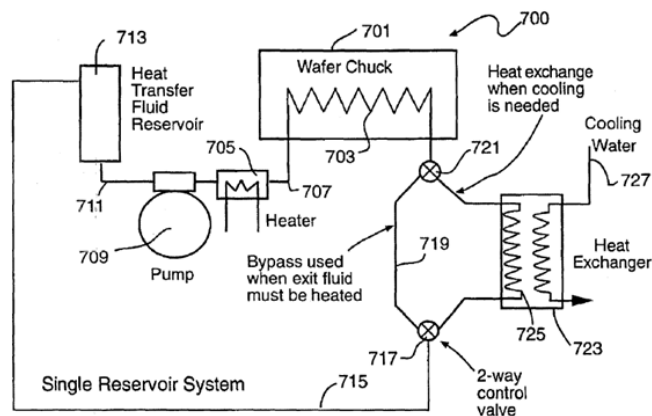
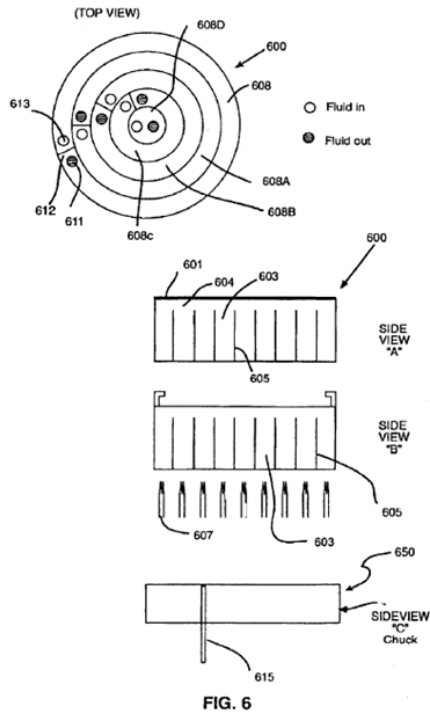


Fig. 7

Figures 6 and 7 depict temperature-controlled fluid flowing through substrate holder (600, 701), guided by baffles 605, where “[t]he fluid [is] used to heat or cool the upper surface of the substrate holder.” Ex. 1001, 14:28–63, 16:5–67. Figure 6 also depicts heating elements 607 underneath the substrate holder, where “[t]he heating elements can selectively heat one or more zones in a desirable manner.” *Id.* at 15:10–26. Referring to Figure 7, the operation of the temperature control system is described as follows:

The desired fluid temperature is determined by comparing the desired wafer or wafer chuck set point temperature to a measured wafer or wafer chuck temperature The heat exchanger, fluid flow rate, coolant-side fluid temperature, heater power, chuck, etc. should be designed using conventional means to permit the heater to bring the fluid to a setpoint temperature and bring the temperature of the chuck and wafer to predetermined

temperatures within specified time intervals and within specified uniformity limits.

Id. at 16:36–39, 16:50–67.

An example of a semiconductor substrate to be patterned is shown in Figure 9, reproduced below.

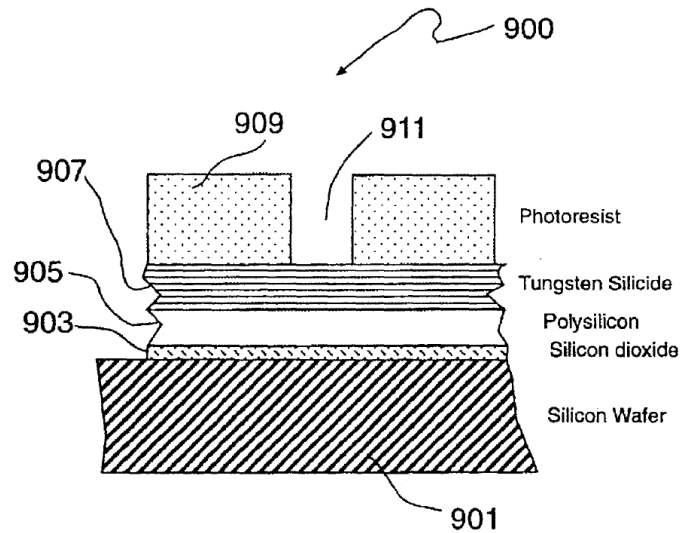


Figure 9 depicts substrate 901 having a stack of layers including oxide layer 903, polysilicon layer 905, tungsten silicide layer 907, and photoresist masking layer 909 with opening 911, from the treatment method shown in Figure 10, reproduced below. Ex. 1001, 17:58–18:57.

Explore Litigation Insights

Docket Alarm provides insights to develop a more informed litigation strategy and the peace of mind of knowing you're on top of things.

Real-Time Litigation Alerts



Keep your litigation team up-to-date with **real-time alerts** and advanced team management tools built for the enterprise, all while greatly reducing PACER spend.

Our comprehensive service means we can handle Federal, State, and Administrative courts across the country.

Advanced Docket Research



With over 230 million records, Docket Alarm's cloud-native docket research platform finds what other services can't. Coverage includes Federal, State, plus PTAB, TTAB, ITC and NLRB decisions, all in one place.

Identify arguments that have been successful in the past with full text, pinpoint searching. Link to case law cited within any court document via Fastcase.

Analytics At Your Fingertips



Learn what happened the last time a particular judge, opposing counsel or company faced cases similar to yours.

Advanced out-of-the-box PTAB and TTAB analytics are always at your fingertips.

API

Docket Alarm offers a powerful API (application programming interface) to developers that want to integrate case filings into their apps.

LAW FIRMS

Build custom dashboards for your attorneys and clients with live data direct from the court.

Automate many repetitive legal tasks like conflict checks, document management, and marketing.

FINANCIAL INSTITUTIONS

Litigation and bankruptcy checks for companies and debtors.

E-DISCOVERY AND LEGAL VENDORS

Sync your system to PACER to automate legal marketing.